



**Advanced Power
Electronics Corp.**

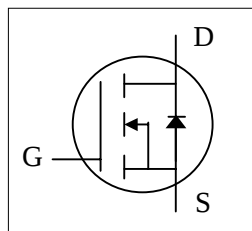
AP0103GP-HF

Halogen-Free Product

N-CHANNEL ENHANCEMENT MODE

POWER MOSFET

- ▼ Simple Drive Requirement
- ▼ Lower On-resistance
- ▼ Fast Switching Characteristic
- ▼ RoHS Compliant & Halogen-Free

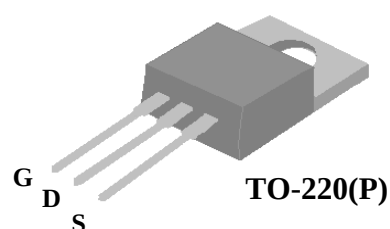


$B_{V_{DS}}@T_J=125^{\circ}\text{C}$	40V
$R_{DS(ON)}$	2.99m Ω
I_D	220A

Description

AP0103 series are from Advanced Power innovated design and silicon process technology to achieve the lowest possible on-resistance and fast switching performance. It provides the designer with an extreme efficient device for use in a wide range of power applications.

The TO-220 package is widely preferred for all commercial-industrial through hole applications. The low thermal resistance and low package cost contribute to the worldwide popular package.



Absolute Maximum Ratings

Symbol	Parameter	Rating	Units
$V_{DS}@T_J=125^{\circ}\text{C}$	Drain-Source Voltage	40	V
V_{GS}	Gate-Source Voltage	+20	V
$I_D@T_C=25^{\circ}\text{C}$	Continuous Drain Current (Chip)	220	A
$I_D@T_C=25^{\circ}\text{C}$	Continuous Drain Current, $V_{GS} @ 10V^3$	80	A
$I_D@T_C=100^{\circ}\text{C}$	Continuous Drain Current, $V_{GS} @ 10V^3$	80	A
I_{DM}	Pulsed Drain Current ¹	320	A
$P_D@T_C=25^{\circ}\text{C}$	Total Power Dissipation	250	W
$P_D@T_A=25^{\circ}\text{C}$	Total Power Dissipation	2	W
T_{STG}	Storage Temperature Range	-55 to 150	$^{\circ}\text{C}$
T_J	Operating Junction Temperature Range	-55 to 150	$^{\circ}\text{C}$

Thermal Data

Symbol	Parameter	Value	Units
Rthj-c	Maximum Thermal Resistance, Junction-case	0.5	$^{\circ}\text{C}/\text{W}$
Rthj-a	Maximum Thermal Resistance, Junction-ambient	62	$^{\circ}\text{C}/\text{W}$



AP0103GP-HF

Electrical Characteristics@T_j=25°C(unless otherwise specified)

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V, I _D =250uA	38	-	-	V
R _{DS(ON)}	Static Drain-Source On-Resistance ²	V _{GS} =10V, I _D =40A	-	-	2.99	mΩ
		V _{GS} =4.5V, I _D =30A	-	-	4.2	mΩ
V _{GS(th)}	Gate Threshold Voltage	V _{DS} =V _{GS} , I _D =250uA	1	-	3	V
g _{fs}	Forward Transconductance	V _{DS} =10V, I _D =40A	-	108	-	S
I _{DSS}	Drain-Source Leakage Current	V _{DS} =32V, V _{GS} =0V	-	-	25	uA
I _{GSS}	Gate-Source Leakage	V _{GS} = ±20V, V _{DS} =0V	-	-	±100	nA
Q _g	Total Gate Charge	I _D =40A	-	30	48	nC
Q _{gs}	Gate-Source Charge	V _{DS} =32V	-	2.3	-	nC
Q _{gd}	Gate-Drain ("Miller") Charge	V _{GS} =4.5V	-	20	-	nC
t _{d(on)}	Turn-on Delay Time	V _{DS} =20V	-	10	-	ns
t _r	Rise Time	I _D =40A	-	80	-	ns
t _{d(off)}	Turn-off Delay Time	R _G =3.3 Ω	-	40	-	ns
t _f	Fall Time	V _{GS} =10V	-	85	-	ns
C _{iss}	Input Capacitance	V _{GS} =0V	-	2760	4410	pF
C _{oss}	Output Capacitance	V _{DS} =25V	-	605	-	pF
C _{rss}	Reverse Transfer Capacitance	f=1.0MHz	-	210	-	pF
R _g	Gate Resistance	f=1.0MHz	-	1.4	2.8	Ω

Source-Drain Diode

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
V _{SD}	Forward On Voltage ²	I _S =40A, V _{GS} =0V	-	-	1.2	V
t _{rr}	Reverse Recovery Time	I _S =10A, V _{GS} =0V,	-	32	-	ns
Q _{rr}	Reverse Recovery Charge	dI/dt=100A/μs	-	24	-	nC

Notes:

- 1.Pulse width limited by Max. junction temperature.
- 2.Pulse test
- 3.Package limitation current is 80A.

THIS PRODUCT IS SENSITIVE TO ELECTROSTATIC DISCHARGE, PLEASE HANDLE WITH CAUTION.

USE OF THIS PRODUCT AS A CRITICAL COMPONENT IN LIFE SUPPORT OR OTHER SIMILAR SYSTEMS IS NOT AUTHORIZED.

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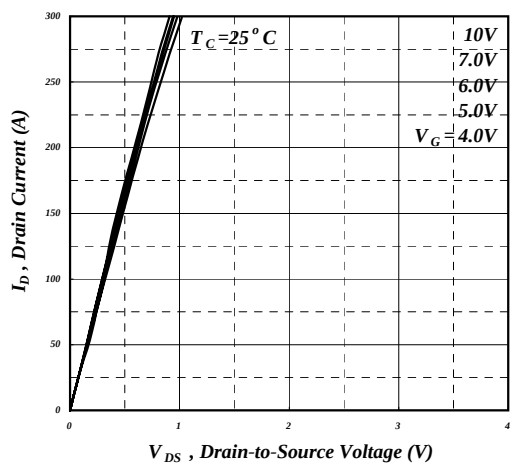


Fig 1. Typical Output Characteristics

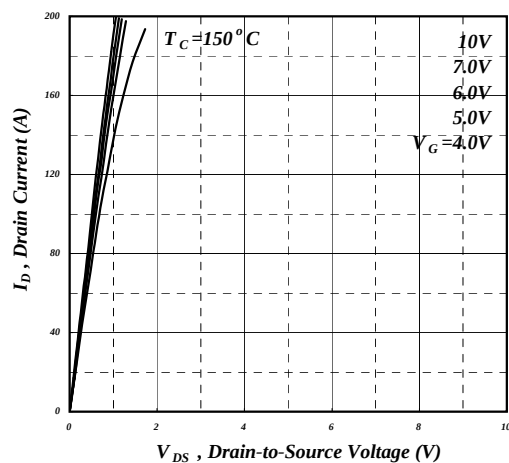


Fig 2. Typical Output Characteristics

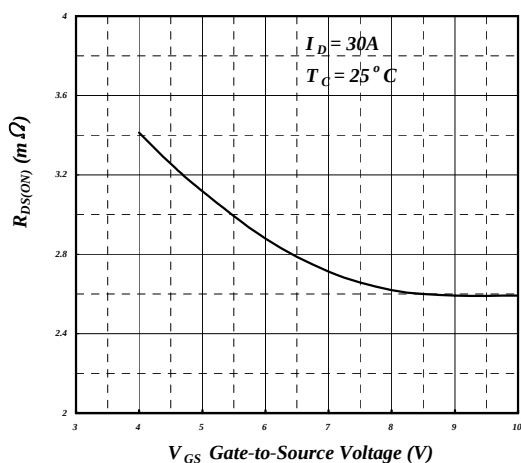


Fig 3. On-Resistance v.s. Gate Voltage

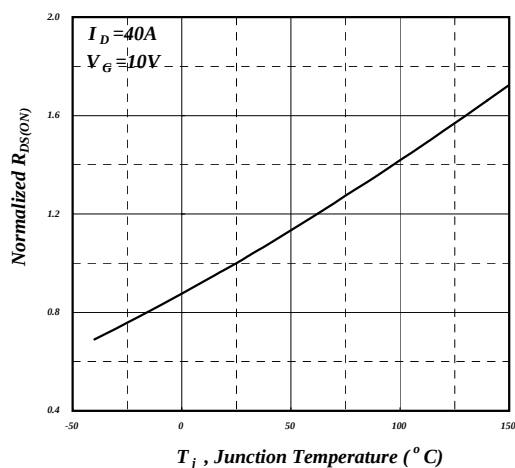


Fig 4. Normalized On-Resistance v.s. Junction Temperature

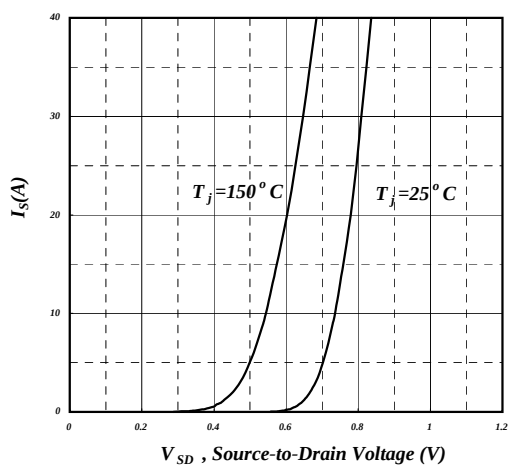


Fig 5. Forward Characteristic of Reverse Diode

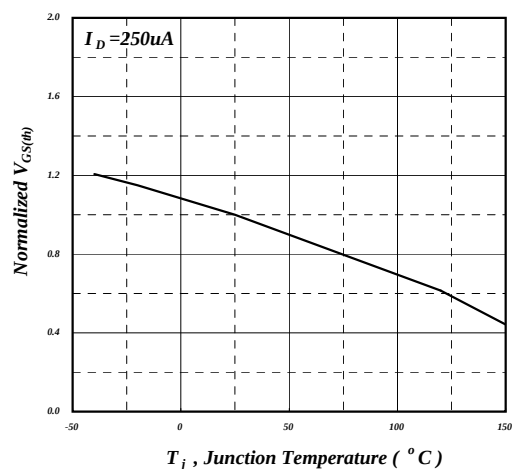


Fig 6. Gate Threshold Voltage v.s. Junction Temperature

